

# 6A High Efficiency DC/DC µModule

## **FEATURES**

- Complete Switch Mode Power Supply
- Wide Input Voltage Range: 4.5V to 20V
- 6A DC, 8A Peak Output Current
- 0.6V to 5V Output Voltage
- 1.5% Output Voltage Regulation
- Ultrafast Transient Response
- Current Mode Control
- Pb-Free (e4) RoHS Compliant Package with Gold-Pad Finish
- Pin Compatible with the LTM4600
- Up to 92% Efficiency
- Programmable Soft-Start
- Output Overvoltage Protection
- Optional Short-Circuit Shutdown Timer
- See the LTM4602HV for Operation Up to 28V<sub>IN</sub>
- Small Footprint, Low Profile (15mm × 15mm × 2.8mm) Surface Mount LGA Package

## **APPLICATIONS**

- Telecom and Networking Equipment
- Servers
- Industrial Equipment
- Point of Load Regulation

## DESCRIPTION

The LTM®4602 is a complete 6A DC/DC step down power supply. Included in the package are the switching controller, power FETs, inductor, and all support components. Operating over an input voltage range of 4.5V to 20V, the LTM4602 supports an output voltage range of 0.6V to 5V, set by a single resistor. This high efficiency design delivers 6A continuous current (8A peak), needing no heat sinks or airflow to meet power specifications. Only bulk input and output capacitors are needed to finish the design.

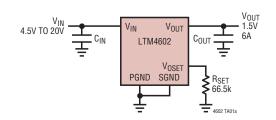
The low profile package (2.8mm) enables utilization of unused space on the bottom of PC boards for high density point of load regulation. High switching frequency and an adaptive on-time current mode architecture enables a very fast transient response to line and load changes without sacrificing stability. Fault protection features include integrated overvoltage and short circuit protection with a defeatable shutdown timer. A built-in soft-start timer is adjustable with a small capacitor.

The LTM4602 is packaged in a thermally enhanced, compact (15mm  $\times$  15mm) and low profile (2.8mm) over-molded Land Grid Array (LGA) package suitable for automated assembly by standard surface mount equipment. For the 4.5V to 28V input range version, refer to the LTM4602HV.

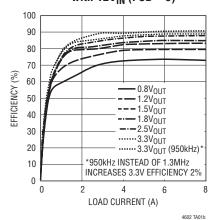
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## TYPICAL APPLICATION

6A µModule<sup>™</sup> Power Supply with 4.5V to 20V Input



## Efficiency vs Load Current with 12V<sub>IN</sub> (FCB = 0)

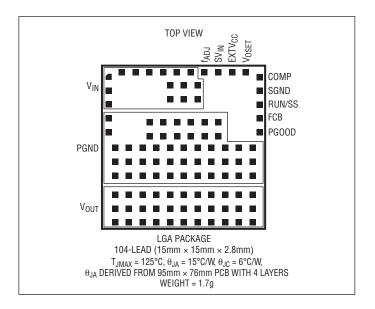


## **ABSOLUTE MAXIMUM RATINGS**

#### (Note 1)

FCB, EXTV <sub>CC</sub> , PGOOD, RUN/SS, V <sub>OUT</sub> –0.3V to 6V
V <sub>IN</sub> , SV <sub>IN</sub> , f <sub>ADJ</sub>
V <sub>OSET</sub> , COMP0.3V to 2.7V
Operating Temperature Range (Note 2)40°C to 85°C
Junction Temperature 125°C
Storage Temperature Range55°C to 125°C

## PIN CONFIGURATION



## ORDER INFORMATION

LEAD FREE FINISH PART MARKING*		PACKAGE DESCRIPTION	TEMPERATURE RANGE		
LTM4602EV#PBF	LTM4602V	104-Lead (15mm × 15mm × 2.8mm) LGA	-40°C to 85°C		
LTM4602IV#PBF	LTM4602V	104-Lead (15mm × 15mm × 2.8mm) LGA	-40°C to 85°C		

Consult LTC Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container. Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

This product is only offered in trays. For more information go to: http://www.linear.com/packaging/

# **ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the $-40^{\circ}$ C to $85^{\circ}$ C temperature range, otherwise specifications are at $T_A = 25^{\circ}$ C, $V_{IN} = 12$ V. External $C_{IN} = 120\mu$ F, $C_{OUT} = 200\mu$ F/Ceramic per typical application (front page) configuration.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V <sub>IN(DC)</sub>	Input DC Voltage		•	4.5		20	V
V <sub>OUT(DC)</sub>	Output Voltage	FCB = 0V V <sub>IN</sub> = 5V or 12V, V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 0A	•	1.478 1.470	1.50 1.50	1.522 1.530	V
Input Specificat	ions						
V <sub>IN(UVLO)</sub>	Under Voltage Lockout Threshold	I <sub>OUT</sub> = 0A			3.4	4	V
I <sub>INRUSH(VIN)</sub>	Input Inrush Current at Startup	$I_{OUT} = 0A. V_{OUT} = 1.5V, FCB = 0$ $V_{IN} = 5V$ $V_{IN} = 12V$			0.6 0.7		A A
I <sub>Q(VIN)</sub>	Input Supply Bias Current	$\begin{split} I_{OUT} &= 0 \text{A, EXTV}_{CC} \text{ Open} \\ V_{IN} &= 12 \text{V, } V_{OUT} = 1.5 \text{V, FCB} = 5 \text{V} \\ V_{IN} &= 12 \text{V, } V_{OUT} = 1.5 \text{V, FCB} = 0 \text{V} \\ V_{IN} &= 5 \text{V, } V_{OUT} = 1.5 \text{V, FCB} = 5 \text{V} \\ V_{IN} &= 5 \text{V, } V_{OUT} = 1.5 \text{V, FCB} = 0 \text{V} \\ \text{Shutdown, RUN} = 0.8 \text{V, } V_{IN} = 12 \text{V} \end{split}$			1.2 42 1.0 52 50	100	mA mA mA mA



## **ELECTRICAL CHARACTERISTICS** The ullet denotes the specifications which apply over the $-40^{\circ}$ C to $85^{\circ}$ C temperature range, otherwise specifications are at $T_A = 25^{\circ}$ C, $V_{IN} = 12$ V. Per typical application (front page) configuration.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
I <sub>S(VIN)</sub>	Input Supply Current	V <sub>IN</sub> = 12V, V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 6A V <sub>IN</sub> = 12V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 6A V <sub>IN</sub> = 5V, V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 6 A		0.88 1.80 2.08		A A A
Output Specifica	tions					
I <sub>OUTDC</sub>	Output Continuous Current Range (See Output Current Derating Curves for Different V <sub>IN</sub> , V <sub>OUT</sub> and T <sub>A</sub> )	V <sub>IN</sub> = 12V, V <sub>OUT</sub> = 1.5V	0		6	A
$\frac{\Delta V_{OUT(LINE)}}{V_{OUT}}$	Line Regulation Accuracy	V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 0A, FCB = 0V, V <sub>IN</sub> = 4.5V to 20V		0.15	0.3	%
$\frac{\Delta V_{OUT(LOAD)}}{V_{OUT}}$	Load Regulation Accuracy	$V_{OUT} = 1.5V$ , $I_{OUT} = 0A$ to 6A, FCB = 0V, $V_{IN} = 5V$ , $V_{IN} = 12V$ (Note 3)		±0.25 ±0.15	±0.5 ±1.0	%
V <sub>OUT(AC)</sub>	Output Ripple Voltage	V <sub>IN</sub> = 12V, V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 0A, FCB = 0V		10	15	mV <sub>P-P</sub>
fs	Output Ripple Voltage Frequency	V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 6A, FCB = 0V		850		kHz
tstart	Turn-On Time	V <sub>OUT</sub> = 1.5V, I <sub>OUT</sub> = 1A V <sub>IN</sub> = 12V V <sub>IN</sub> = 5V		0.5 0.7		ms ms
ΔV <sub>OUTLS</sub>	Voltage Drop for Dynamic Load Step	V <sub>OUT</sub> = 1.5V, Load Step: 0A/µs to 3A/µs C <sub>OUT</sub> = 22µF 6.3V, 330µF 4V POSCAP, See Table 2		30		mV
t <sub>SETTLE</sub>	Settling Time for Dynamic Load Step	Load: 10% to 50% to 10% of Full Load		25		μs
I <sub>OUTPK</sub>	Output Current Limit	Output Voltage in Foldback  V <sub>IN</sub> = 12V, V <sub>OUT</sub> = 1.5V  V <sub>IN</sub> = 5V, V <sub>OUT</sub> = 1.5V	9			A
Control Stage						
V <sub>OSET</sub>	Voltage at V <sub>OSET</sub> Pin	I <sub>OUT</sub> = 0A, V <sub>OUT</sub> = 1.5V	0.591	0.6	0.609	V
V <sub>RUN/SS</sub>	RUN ON/OFF Threshold		0.8	1.5	2	V
I <sub>RUN(C)/SS</sub>	Soft-Start Charging Current	V <sub>RUN/SS</sub> = 0V	-0.5	-1.2	-3	μΑ
I <sub>RUN(D)/SS</sub>	Soft-Start Discharging Current	V <sub>RUN/SS</sub> = 4V	0.8	1.8	3	μА
V <sub>IN</sub> – SV <sub>IN</sub>		EXTV <sub>CC</sub> = 0V, FCB = 0V		100		m۷
IEXTVCC	Current into EXTV <sub>CC</sub> Pin	$\begin{aligned} EXTV_{CC} &= 5V,  FCB = 0V,  V_{OUT} = 1.5V, \\ I_{OUT} &= 0A \end{aligned}$		16		mA
R <sub>FBHI</sub>	Resistor Between V <sub>OUT</sub> and V <sub>OSET</sub> Pins			100		kΩ
V <sub>FCB</sub>	Forced Continuous Threshold		0.57	0.6	0.63	V
I <sub>FCB</sub>	Forced Continuous Pin Current	V <sub>FCB</sub> = 0.6V		-1	-2	μΑ
PGOOD Output						
ΔV <sub>OSETH</sub>	PGOOD Upper Threshold	V <sub>OSET</sub> Rising	7.5	10	12.5	%
ΔV <sub>OSETL</sub>	PGOOD Lower Threshold	V <sub>OSET</sub> Falling	-7.5	-10	-12.5	%
ΔV <sub>OSET(HYS)</sub>	PG00D Hysteresis	V <sub>OSET</sub> Returning		2		%
V <sub>PGL</sub>	PGOOD Low Voltage	I <sub>PGOOD</sub> = 5mA		0.15	0.4	V

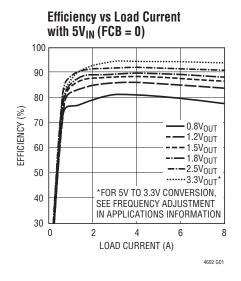
**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

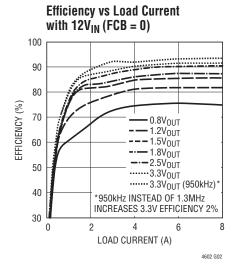
**Note 2:** The LTM4602E is guaranteed to meet performance specifications from 0°C to 85°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls. The LTM4602I is guaranteed over the -40°C to 85°C temperature range.

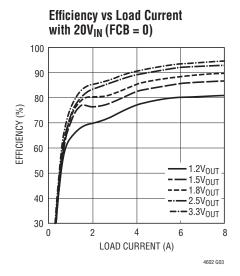
Note 3: Test assumes current derating versus temperature.

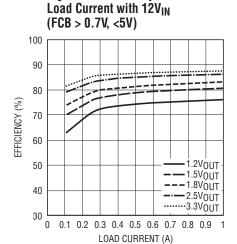


## TYPICAL PERFORMANCE CHARACTERISTICS (See Figure 21 for all curves)

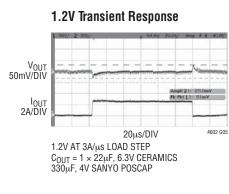


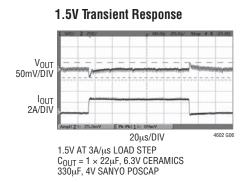




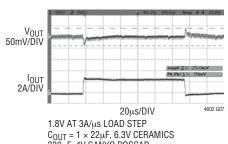


**Light Load Efficiency vs** 



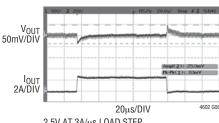


## 1.8V Transient Response



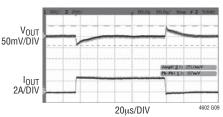
 $C_{OUT}$  = 1 × 22 $\mu$ F, 6.3V CERAMICS 330 $\mu$ F, 4V SANYO POSCAP

#### 2.5V Transient Response



2.5V AT 3A/µs LOAD STEP  $C_{OUT}$  = 1 × 22 $\mu$ F, 6.3V CERAMICS 330 $\mu$ F, 4V SANYO POSCAP

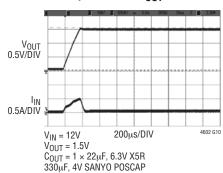
#### 3.3V Transient Response



3.3V AT 3A/µs LOAD STEP  $C_{OUT}$  = 1 × 22 $\mu$ F, 6.3V CERAMICS 330 $\mu$ F, 4V SANYO POSCAP

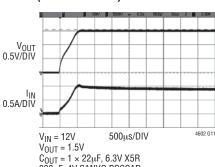
## TYPICAL PERFORMANCE CHARACTERISTICS (See Figure 21 for all curves)

Start-Up, No Load,  $I_{OUT} = 0A$ 



NO EXTERNAL SOFT-START CAPACITOR

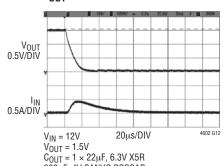
Start-Up, I<sub>OUT</sub> = 6A (Resistive Load)



C<sub>OUT</sub> = 1 × 22μF, 6.3V X5R 330μF, 4V SANYO POSCAP

NO EXTERNAL SOFT-START CAPACITOR

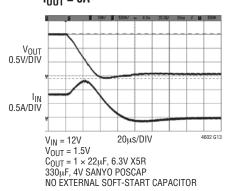
#### **Short-Circuit Protection**, $I_{OUT} = 0A$



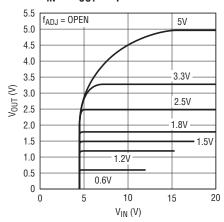
C<sub>OUT</sub> = 1 × 22μF, 6.3V X5R 330μF, 4V SANYO POSCAP

NO EXTERNAL SOFT-START CAPACITOR

#### **Short-Circuit Protection,** $I_{OUT} = 6A$



#### V<sub>IN</sub> to V<sub>OUT</sub> Step-Down Ratio



SEE FREQUENCY ADJUSTMENT DISCUSSION FOR 12V $_{\rm IN}$  TO 5V $_{\rm OUT}$  AND 5V $_{\rm IN}$  TO 3.3V $_{\rm OUT}$  CONVERSION

## PIN FUNCTIONS (See Package Description for Pin Assignment)

 $V_{IN}$  (Bank 1): Power Input Pins. Apply input voltage between these pins and PGND pins. Recommend placing input decoupling capacitance directly between  $V_{IN}$  pins and PGND pins.

 $f_{ADJ}$  (Pin A15): A 110k resistor from  $V_{IN}$  to this pin sets the one-shot timer current, thereby setting the switching frequency. The LTM4602 switching frequency is typically 850kHz. An external resistor to ground can be selected to reduce the one-shot timer current, thus lower the switching frequency to accommodate a higher duty cycle step down requirement. See the applications section.

**SV**<sub>IN</sub> (**Pin A17**): Supply Pinfor Internal PWM Controller. Leave this pin open or add additional decoupling capacitance.

**EXTV**<sub>CC</sub> (**Pin A19**): External 5V supply pin for controller. If left open or grounded, the internal 5V linear regulator will power the controller and MOSFET drivers. For high input voltage applications, connecting this pin to an external 5V will reduce the power loss in the power module. The EXTV<sub>CC</sub> voltage should never be higher than  $V_{IN}$ .

 $V_{OSET}$  (Pin A21): The Negative Input of The Error Amplifier. Internally, this pin is connected to  $V_{OUT}$  with a 100k precision resistor. Different output voltages can be programmed with additional resistors between the  $V_{OSET}$  and SGND pins.

**COMP (Pin B23):** Current Control Threshold and Error Amplifier Compensation Point. The current comparator threshold increases with this control voltage. The voltage ranges from 0V to 2.4V with 0.8V corresponding to zero sense voltage (zero current).

**SGND (Pin D23):** Signal Ground Pin. All small-signal components should connect to this ground, which in turn connects to PGND at one point.

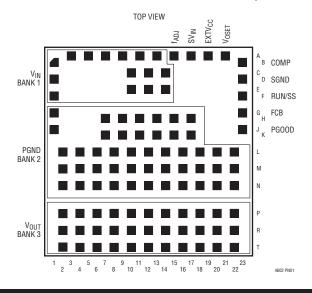
**RUN/SS (Pin F23):** Run and Soft-Start Control. Forcing this pin below 0.8V will shut down the power supply. Inside the power module, there is a 1000pF capacitor which provides approximately 0.7ms soft-start time with 200µF output capacitance. Additional soft-start time can be achieved by adding additional capacitance between the RUN/SS and SGND pins. The internal short-circuit latchoff can be disabled by adding a resistor between this pin and the  $V_{\text{IN}}$  pin. This pullup resistor must supply a minimum 5µA pull up current.

**FCB (Pin G23):** Forced Continuous Input. Grounding this pin enables forced continuous mode operation regardless of load conditions. Tying this pin above 0.63V enables discontinuous conduction mode to achieve high efficiency operation at light loads. There is an internal 4.75k resistor between the FCB and SGND pins.

**PGOOD (Pin J23):** Output Voltage Power Good Indicator. When the output voltage is within 10% of the nominal voltage, the PGOOD is open drain output. Otherwise, this pin is pulled to ground.

**PGND (Bank 2):** Power ground pins for both input and output returns.

**V<sub>OUT</sub>** (**Bank 3**): Power Output Pins. Apply output load between these pins and PGND pins. Recommend placing High Frequency output decoupling capacitance directly between these pins and PGND pins.





## SIMPLIFIED BLOCK DIAGRAM

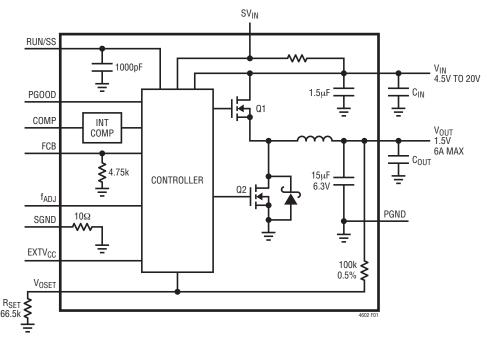


Figure 1. Simplified LTM4602 Block Diagram

## **DECOUPLING REQUIREMENTS** $T_A = 25^{\circ}C$ , $V_{IN} = 12V$ . Use Figure 1 configuration.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
C <sub>IN</sub>	External Input Capacitor Requirement (V <sub>IN</sub> = 4.5V to 20V, V <sub>OUT</sub> = 1.5V)	I <sub>OUT</sub> = 6A		20			μF
C <sub>OUT</sub>	External Output Capacitor Requirement (V <sub>IN</sub> = 4.5V to 20V, V <sub>OUT</sub> = 1.5V)	I <sub>OUT</sub> = 6A, Refer to Table 2 in the Applications Information Section		100	200	·	μF

## **OPERATION**

#### µModule Description

The LTM4602 is a standalone nonisolated synchronous switching DC/DC power supply. It can deliver up to 6A of DC output current with only bulk external input and output capacitors. This module provides a precisely regulated output voltage programmable via one external resistor from  $0.6 V_{DC}$  to  $5.0 V_{DC},$  not to exceed 80% of the input voltage. The input voltage range is 4.5V to 20V. A simplified block diagram is shown in Figure 1 and the typical application schematic is shown in Figure 21.

The LTM4602 contains an integrated LTC constant on-time current-mode regulator, ultralow  $R_{DS(0N)}$  FETs with fast switching speed and integrated Schottky diode. The typical switching frequency is 850kHz at full load. With current mode control and internal feedback loop compensation, the LTM4602 module has sufficient stability margins and good transient performance under a wide range of operating conditions and with a wide range of output capacitors, even all ceramic output capacitors (X5R or X7R).

Current mode control provides cycle-by-cycle fast current limit. In addition, foldback current limiting is provided in an overcurrent condition while  $V_{OSET}$  drops. Also, the LTM4602 has defeatable short-circuit latch off. Internal overvoltage and undervoltage comparators pull the opendrain PG00D output low if the output feedback voltage exits a  $\pm 10\%$  window around the regulation point. Furthermore,

in an overvoltage condition, internal top FET Q1 is turned off and bottom FET Q2 is turned on and held on until the overvoltage condition clears.

Pulling the RUN/SS pin low forces the controller into its shutdown state, turning off both Q1 and Q2. Releasing the pin allows an internal 1.2 $\mu$ A current source to charge up the soft-start capacitor. When this voltage reaches 1.5V, the controller turns on and begins switching.

At low load current the module works in continuous current mode by default to achieve minimum output voltage ripple. It can be programmed to operate in discontinuous current mode for improved light load efficiency when the FCB pin is pulled up above 0.8V and no higher than 6V. The FCB pin has a 4.75k resistor to ground, so a resistor to  $V_{\text{IN}}$  can set the voltage on the FCB pin.

When EXTV<sub>CC</sub> pin is grounded or open, an integrated 5V linear regulator powers the controller and MOSFET gate drivers. If a minimum 4.7V external bias supply is applied on the EXTV<sub>CC</sub> pin, the internal regulator is turned off, and an internal switch connects EXTV<sub>CC</sub> to the gate driver voltage. This eliminates the linear regulator power loss with high input voltage, reducing the thermal stress on the controller. The maximum voltage on EXTV<sub>CC</sub> pin is 6V. The EXTV<sub>CC</sub> voltage should never be higher than the  $V_{\text{IN}}$  voltage. Also EXTV<sub>CC</sub> must be sequenced after  $V_{\text{IN}}$ .

The typical LTM4602 application circuit is shown in Figure 21. External component selection is primarily determined by the maximum load current and output voltage.

#### **Output Voltage Programming and Margining**

The PWM controller of the LTM4602 has an internal 0.6V reference voltage. As shown in the block diagram, a 100k/0.5% internal feedback resistor connects  $V_{OUT}$  and  $V_{OSET}$  pins. Adding a resistor  $R_{SET}$  from  $V_{OSET}$  pin to SGND pin programs the output voltage:

$$V_{OUT} = 0.6V \bullet \frac{100k + R_{SET}}{R_{SET}}$$

Table 1 shows the standard values of 1% R<sub>SET</sub> resistor for typical output voltages:

Table 1

$R_{SET}$ (k $\Omega$ )	Open	100	66.5	49.9	43.2	31.6	22.1	13.7
V <sub>OUT</sub> (V)	0.6	1.2	1.5	1.8	2	2.5	3.3	5

Voltage margining is the dynamic adjustment of the output voltage to its worst case operating range in production testing to stress the load circuitry, verify control/protection functionality of the board and improve the system reliability. Figure 2 shows how to implement margining function with the LTM4602. In addition to the feedback resistor  $R_{\text{SET}}$ , several external components are added. Turn off both transistor  $Q_{\text{UP}}$  and  $Q_{\text{DOWN}}$  to disable the margining. When  $Q_{\text{UP}}$  is on and  $Q_{\text{DOWN}}$  is off, the output voltage is margined down when  $Q_{\text{DOWN}}$  is on and  $Q_{\text{UP}}$  is off. If the output

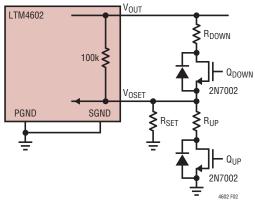


Figure 2. LTM4602 Margining Implementation

voltage  $V_{OUT}$  needs to be margined up/down by  $\pm M\%$ , the resistor values of  $R_{UP}$  and  $R_{DOWN}$  can be calculated from the following equations:

$$\frac{(R_{SET} || R_{UP}) \bullet V_{OUT} \bullet (1+M\%)}{(R_{SET} || R_{UP}) + 100k\Omega} = 0.6V$$

$$\frac{R_{SET} \bullet V_{OUT} \bullet (1-M\%)}{R_{SET} + (100k\Omega \|R_{DOWN})} = 0.6V$$

#### **Input Capacitors**

The LTM4602  $\mu$ Module should be connected to a low AC-impedance DC source. High frequency, low ESR input capacitors are required to be placed adjacent to the module. In Figure 21, the bulk input capacitor  $C_{IN}$  is selected for its ability to handle the large RMS current into the converter. For a buck converter, the switching duty cycle can be estimated as:

$$D = \frac{V_{OUT}}{V_{IN}}$$

Without considering the inductor current ripple, the RMS current of the input capacitor can be estimated as:

$$I_{CIN(RMS)} = \frac{I_{OUT(MAX)}}{\eta\%} \bullet \sqrt{D \bullet (1-D)}$$

In the above equation,  $\eta\%$  is the estimated efficiency of the power module. C1 can be a switcher-rated electrolytic aluminum capacitor, OS-CON capacitor or high volume ceramic capacitors. Note the capacitor ripple current ratings are often based on only 2000 hours of life. This makes it advisable to properly derate the input capacitor, or choose a capacitor rated at a higher temperature than required. Always contact the capacitor manufacturer for derating requirements.

In Figure 21, the input capacitors are used as high frequency input decoupling capacitors. In a typical 6A output application, 1-2 pieces of very low ESR X5R or X7R,  $10\mu\text{F}$  ceramic capacitors are recommended. This decoupling capacitor should be placed directly adjacent the module input pins in the PCB layout to minimize the trace inductance and high frequency AC noise.

#### **Output Capacitors**

The LTM4602 is designed for low output voltage ripple. The bulk output capacitors  $C_{OUT}$  is chosen with low enough effective series resistance (ESR) to meet the output voltage ripple and transient requirements.  $C_{OUT}$  can be low ESR tantalum capacitor, low ESR polymer capacitor or ceramic capacitor (X5R or X7R). The typical capacitance is 200µF if all ceramic output capacitors are used. The internally optimized loop compensation provides sufficient stability margin for all ceramic capacitors applications. Additional output filtering may be required by the system designer, if further reduction of output ripple or dynamic transient spike is required. Refer to Table 2 for an output capacitance matrix for each output voltage droop, peak to peak deviation and recovery time during a  $3A/\mu s$  transient with a specific output capacitance.

## Fault Conditions: Current Limit and Overcurrent Foldback

The LTM4602 has a current mode controller, which inherently limits the cycle-by-cycle inductor current not only in steady-state operation, but also in transient.

To further limit current in the event of an over load condition, the LTM4602 provides foldback current limiting. If the output voltage falls by more than 50%, then the maximum output current is progressively lowered to about one sixth of its full current limit value.

#### Soft-Start and Latchoff with the RUN/SS pin

The RUN/SS pin provides a means to shut down the LTM4602 as well as a timer for soft-start and overcurrent latchoff. Pulling the RUN/SS pin below 0.8V puts the LTM4602 into a low quiescent current shutdown (IQ  $\leq$  100µA). Releasing the pin allows an internal 1.2µA current source to charge up the timing capacitor CSS. Inside LTM4602, there is an internal 1000pF capacitor from RUN/SS pin to ground. If RUN/SS pin has an external capacitor CSS EXT to ground, the delay before starting is about:

$$t_{DELAY} = \frac{1.5V}{1.2\mu A} \bullet (C_{SS\_EXT} + 1000pF)$$

When the voltage on RUN/SS pin reaches 1.5V, the LTM4602 internal switches are operating with a clamping of the maximum output inductor current limited by the RUN/SS pin total soft-start capacitance. As the RUN/SS pin voltage rises to 3V, the soft-start clamping of the inductor current is released.

## **VIN to VOLIT Step-Down Ratios**

There are restrictions in the maximum  $V_{IN}$  to  $V_{OUT}$  step down ratio that can be achieved for a given input voltage. These constraints are shown in the Typical Performance Characteristics curves labeled " $V_{IN}$  to  $V_{OUT}$  Step-Down Ratio". Note that additional thermal derating may apply. See the Thermal Considerations and Output Current Derating sections of this data sheet.



Table 2. Output Voltage Response Versus Component Matrix (Refer to Figure 21), OA to 3A Step (Typical Values)

#### TYPICAL MEASURED VALUES

C <sub>OUT1</sub> VENDORS	PART NUMBER	C <sub>OUT2</sub> VENDORS	PART NUMBER
TDK	C4532X5R0J107MZ (100µF,6.3V)	SANYO POSCAP	6TPE330MIL (330μF, 6.3V)
TAIYO YUDEN	JMK432BJ107MU-T ( 100μF, 6.3V)	SANYO POSCAP	2R5TPE470M9 (470μF, 2.5V)
TAIYO YUDEN	JMK316BJ226ML-T501 ( 22μF, 6.3V)	SANYO POSCAP	4TPE470MCL (470μF, 4V)

V <sub>OUT</sub> (V)	C <sub>IN</sub> (CERAMIC)	C <sub>IN</sub> (BULK)	C <sub>OUT1</sub> (CERAMIC)	C <sub>OUT2</sub> (BULK)	C <sub>COMP</sub>	C3	V <sub>IN</sub> (V)	DROOP (mV)	PEAK TO PEAK (mV)	RECOVERY TIME (µs)	LOAD STEP (A/µs)
1.2	$2 \times 10 \mu F 25V$	150µF 35V	3 × 22μF 6.3V	470μF 4V	NONE	100pF	5	50	60	25	3
1.2	$2 \times 10 \mu F 25 V$	150µF 35V	1 × 100µF 6.3V	470μF 2.5V	NONE	100pF	5	30	60	20	3
1.2	$2 \times 10 \mu F 25 V$	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	100pF	5	25	54	20	3
1.2	$2 \times 10 \mu F 25 V$	150µF 35V	4 × 100μF 6.3V	NONE	NONE	100pF	5	25	55	20	3
1.2	$2 \times 10 \mu F 25 V$	150μF 35V	3 × 22μF 6.3V	470μF 4V	NONE	100pF	12	30	60	25	3
1.2	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470μF 2.5V	NONE	100pF	12	25	54	20	3
1.2	$2 \times 10 \mu F 25 V$	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	100pF	12	25	50	20	3
1.2	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	100pF	12	25	55	20	3
1.5	2 × 10μF 25V	150µF 35V	3 × 22μF 6.3V	470μF 4V	NONE	100pF	5	25	50	25	3
1.5	2 × 10μF 25V	150μF 35V	1 × 100µF 6.3V	470μF 2.5V	NONE	100pF	5	25	54	20	3
1.5	2 × 10μF 25V	150μF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	100pF	5	28	59	20	3
1.5	2 × 10μF 25V	150μF 35V	4 × 100μF 6.3V	NONE	NONE	100pF	5	26	59	20	3
1.5	2 × 10μF 25V	150μF 35V	3 × 22μF 6.3V	470μF 4V	NONE	100pF	12	25	55	25	3
1.5	2 × 10μF 25V	150μF 35V	1 × 100µF 6.3V	470μF 2.5V	NONE	100pF	12	25	54	20	3
1.5	2 × 10μF 25V	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	100pF	12	28	59	20	3
1.5	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	100pF	12	26	59	20	3
1.8	2 × 10μF 25V	150µF 35V	3 × 22μF 6.3V	470µF 4V	NONE	100pF	5	25	54	30	3
1.8	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470μF 2.5V	NONE	100pF	5	25	50	20	3
1.8	2 × 10μF 25V	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	100pF	5	25	50	20	3
1.8	2 × 10µF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	100pF	5	29	60	20	3
1.8	2 × 10μF 25V	150µF 35V	3 × 22μF 6.3V	470µF 4V	NONE	100pF	12	25	50	30	3
1.8	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470μF 2.5V	NONE	100pF	12	25	50	20	3
1.8	2 × 10μF 25V	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	100pF	12	25	50	20	3
1.8	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	100pF	12	29	60	20	3
2.5	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470µF 4V	NONE	220pF	5	25	50	30	3
2.5	2 × 10µF 25V	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	220pF	5	25	50	30	3
2.5	2 × 10μF 25V	150µF 35V	3 × 22μF 6.3V	470µF 4V	NONE	220pF	5	25	50	30	3
2.5	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	220pF	5	25	50	25	3
2.5	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470µF 4V	NONE	220pF	12	25	50	30	3
2.5	2 × 10μF 25V	150µF 35V	3 × 22μF 6.3V	470µF 4V	NONE	220pF	12	25	50	30	3
2.5	2 × 10μF 25V	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	220pF	12	25	50	30	3
2.5	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	220pF	12	27	54	25	3
3.3	2 × 10μF 25V	150µF 35V	2 × 100µF 6.3V	330µF 6.3V	NONE	220pF	7	32	64	30	3
3.3	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470µF 4V	NONE	220pF	7	30	60	30	3
3.3	2 × 10μF 25V	150µF 35V	3 × 22µF 6.3V	470μF 4V	NONE	220pF	7	30	60	35	3
3.3	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	220pF	7	32	64	25	3
3.3	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	470μF 4V	NONE	220pF	12	38	58	30	3
3.3	2 × 10μF 25V	150µF 35V	3 × 22μF 6.3V	470μF 4V	NONE	220pF	12	30	60	35	3
3.3	2 × 10µF 25V	150µF 35V	2 × 100µF 6.3V	330μF 6.3V	NONE	220pF	12	30	60	30	3
3.3	2 × 10μF 25V	150µF 35V	4 × 100μF 6.3V	NONE	NONE	220pF	12	32	64	25	3
5	2 × 10μF 25V	150µF 35V	1 × 100µF 6.3V	NONE	NONE	100pF	15	80	160	25	3
5	2 × 10µF 25V	150µF 35V	1 × 100μF 6.3V	NONE	NONE	100pF	20	80	160	25	3

After the controller has been started and given adequate time to charge up the output capacitor,  $C_{SS}$  is used as a short-circuit timer. After the RUN/SS pin charges above 4V, if the output voltage falls below 75% of its regulated value, then a short-circuit fault is assumed. A 1.8µA current then begins discharging  $C_{SS}$ . If the fault condition persists until the RUN/SS pin drops to 3.5V, then the controller turns off both power MOSFETs, shutting down the converter permanently. The RUN/SS pin must be actively pulled down to ground in order to restart operation.

The overcurrent protection timer requires the soft-start timing capacitor  $C_{SS}$  be made large enough to guarantee that the output regulation by the time  $C_{SS}$  has reached the 4V threshold. In general, this will depend upon the size of the output capacitance, output voltage and load current characteristic. A minimum external soft-start capacitor can be estimated from:

$$C_{SS\_EXT} + 1000pF > C_{OUT} \cdot V_{OUT} (10^{-3}[F/V_S])$$

Generally 0.1µF is more than sufficient.

Since the load current is already limited by the current mode control and current foldback circuitry during a short circuit, overcurrent latchoff operation is NOT always needed or desired, especially if the output has large capacitance or the load draws high current during start up. The latchoff feature can be overridden by a pull-up current greater than 5 $\mu$ A but less than 80 $\mu$ A to the RUN/SS pin. The additional current prevents the discharge of CSS during a fault and also shortens the soft-start period. Using a resistor from RUN/SS pin to VIN is a simple solution to defeat latchoff. Any pull-up network must be able to maintain RUN/SS above

4V maximum latchoff threshold and overcome the  $4\mu A$  maximum discharge current. Figure 3 shows a conceptual drawing of  $V_{RUN}$  during start-up and short circuit.

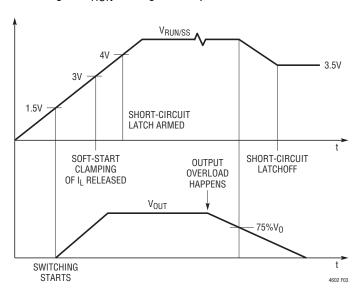
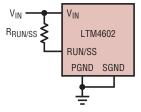


Figure 3. RUN/SS Pin Voltage During Startup and Short-Circuit Protection



#### RECOMMENDED VALUES FOR RRUN/SS

V <sub>IN</sub>	R <sub>RUN/SS</sub>	
4.5V TO 5.5V	50k	
10.8V TO 13.8V	150k	
16V TO 20V	330k	4602 FI

Figure 4. Defeat Short-Circuit Latchoff with a Pull-Up Resistor to  $\mbox{\sc V}_{\mbox{\scriptsize IN}}$ 

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#### **Enable**

The RUN/SS pin can be driven from logic as shown in Figure 5. This function allows the LTM4602 to be turned on or off remotely. The  $\overline{\text{ON}}$  signal can also control the sequence of the output voltage.

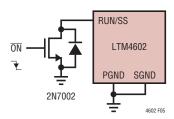


Figure 5. Enable Circuit with External Logic

#### **Output Voltage Tracking**

For the applications that require output voltage tracking, several LTM4602 modules can be programmed by the power supply tracking controller such as the LTC2923. Figure 6 shows a typical schematic with LTC2923. Coincident, ratiometric and offset tracking for  $V_{OUT}$  rising and falling can be implemented with different sets of resistor values. See the LTC2923 data sheet for more details.

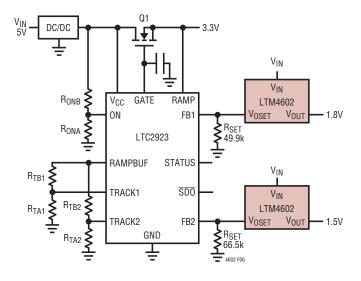


Figure 6. Output Voltage Tracking with the LTC2923 Controller

#### **EXTV<sub>CC</sub> Connection**

An internal low dropout regulator produces an internal 5V supply that powers the control circuitry and FET drivers. Therefore, if the system does not have a 5V power rail, the LTM4602 can be directly powered by  $V_{IN}$ . The gate driver current through LDO is about 18mA. The internal LDO power dissipation can be calculated as:

$$P_{LDO\ LOSS} = 18mA \cdot (V_{IN} - 5V)$$

The LTM4602 also provides an external gate driver voltage pin EXTV $_{CC}$ . If there is a 5V rail in the system, it is recommended to connect EXTV $_{CC}$  pin to the external 5V rail. Whenever the EXTV $_{CC}$  pin is above 4.7V, the internal 5V LDO is shut off and an internal 50mA P-channel switch connects the EXTV $_{CC}$  to internal 5V. Internal 5V is supplied from EXTV $_{CC}$  until this pin drops below 4.5V. Do not apply more than 6V to the EXTV $_{CC}$  pin and ensure that EXTV $_{CC}$  < V $_{IN}$ . The following list summaries the possible connections for EXTV $_{CC}$ :

- 1. EXTV $_{\rm CC}$  grounded. Internal 5V LDO is always powered from the internal 5V regulator.
- 2. EXTV<sub>CC</sub> connected to an external supply. Internal LDO is shut off. A high efficiency supply compatible with the MOSFET gate drive requirements (typically 5V) can improve overall efficiency. With this connection, it is always required that the EXTV<sub>CC</sub> voltage can not be higher than  $V_{IN}$  pin voltage.

#### **Discontinuous Operation and FCB Pin**

The FCB pin determines whether the internal bottom MOSFET remains on when the inductor current reverses. There is an internal 4.75k pull-down resistor connecting this pin to ground. The default light load operation mode is forced continuous (PWM) current mode. This mode provides minimum output voltage ripple.

In the application where the light load efficiency is important, tying the FCB pin above 0.6V threshold enables discontinuous operation where the bottom MOSFET turns off when inductor current reverses. Therefore, the conduc-



tion loss is minimized and light load efficiency is improved. The penalty is that the controller may skip cycle and the output voltage ripple increases at light load.

#### Paralleling Operation with Load Sharing

Two or more LTM4602 modules can be paralleled to provide higher than 6A output current. Figure 7 shows the necessary interconnection between two paralleled modules. The OPTI-LOOP® current mode control ensures good current sharing among modules to balance the thermal stress. The new feedback equation for two or more LTM4602s in parallel is:

$$V_{OUT} = 0.6V \bullet \frac{\frac{100k}{N} + R_{SET}}{R_{SET}}$$

where N is the number of LTM4602s in parallel.

#### Thermal Considerations and Output Current Derating

The power loss curves in Figures 8 and 13 can be used in coordination with the load current derating curves in Figures 9 to 12, and Figures 14 to 15 for calculating an approximate  $\theta_{JA}$  for the module with various heat

sinking methods. Thermal models are derived from several temperature measurements at the bench, and thermal modeling analysis. Application Note 103 provides a detailed explanation of the analysis for the thermal models, and the derating curves. Tables 3 and 4 provide a summary of the equivalent  $\theta_{JA}$  for the noted conditions. These equivalent  $\theta_{JA}$  parameters are correlated to the measured values, and improve with air-flow. The case temperature is maintained at 100°C or below for the derating curves. This allows for 4W maximum power dissipation in the total module with top and bottom heat sinking, and 2W power dissipation through the top of the module with an approximate θ<sub>JC</sub> between 6°C/W to 9°C/W. This equates to a total of 124°C at the junction of the device. The  $\theta_{JA}$  values in Tables 3 and 4 can be used to derive the derating curves for other output voltages.

#### **Safety Considerations**

The LTM4602 modules do not provide isolation from  $V_{IN}$  to  $V_{OUT}$ . There is no internal fuse. If required, a slow blow fuse with a rating twice the maximum input current should be provided to protect each unit from catastrophic failure.

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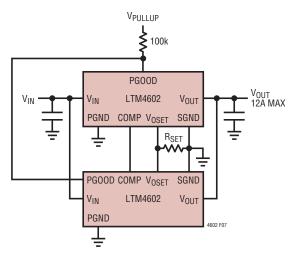
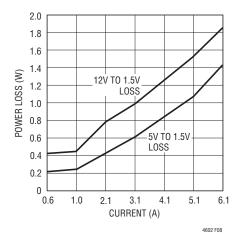
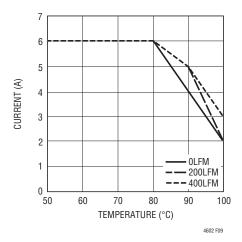


Figure 7. Parallel Two µModules with Load Sharing

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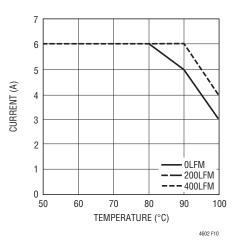
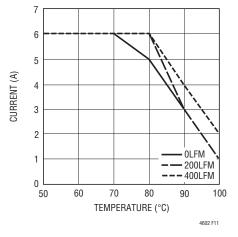
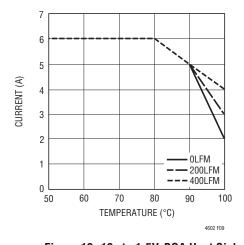


Figure 8. 1.5V Power Loss vs Load Current

Figure 9. 5V to 1.5V, No Heat Sink

Figure 10. 5V to 1.5V, BGA Heat Sink





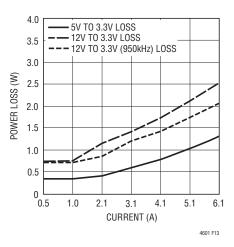
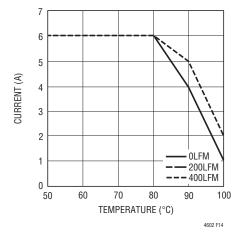
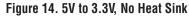


Figure 11. 12V to 1.5V, No Heat Sink

Figure 12. 12v to 1.5V, BGA Heat Sink

Figure 13. 3.3V Power Loss vs Load Current





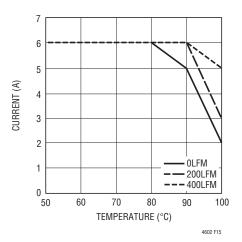


Figure 15. 5V to 3.3V, BGA Heat Sink

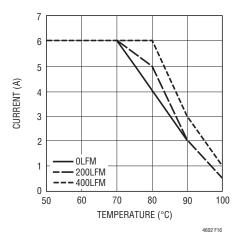


Figure 16. 12V to 3.3V, No Heat Sink

Table 3. 1.5V Output

AIR FLOW (LFM)	HEAT SINK	θ <sub>JA</sub> (°C/W)
0	None	15.2
200	None	14
400	None	12
0	BGA Heat Sink	13.9
200	BGA Heat Sink	11.3
400	BGA Heat Sink	10.25

#### Layout Checklist/Example

The high integration of the LTM4602 makes the PCB board layout very simple and easy. However, to optimize its electrical and thermal performance, some layout considerations are still necessary.

- Use large PCB copper areas for high current path, including V<sub>IN</sub>, PGND and V<sub>OUT</sub>. It helps to minimize the PCB conduction loss and thermal stress.
- Place high frequency ceramic input and output capacitors next to the V<sub>IN</sub>, PGND and V<sub>OUT</sub> pins to minimize high frequency noise.
- Place a dedicated power ground layer underneath the unit.
- To minimize the via conduction loss and reduce module thermal stress, use multiple vias for interconnection between top layer and other power layers.
- Do not put vias directly on pads unless they are capped.

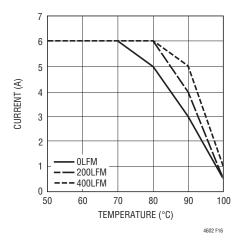


Figure 17. 12V to 3.3V, BGA Heat Sink

Table 4. 3.3V Output

AIR FLOW (LFM)	HEAT SINK	θ <sub>JA</sub> (°C/W)		
0	None	15.2		
200	None	14.6		
400	None	13.4		
0	BGA Heat Sink	13.9		
200	BGA Heat Sink	11.1		
400	BGA Heat Sink	10.5		

 Use a separated SGND ground copper area for components connected to signal pins. Connect the SGND to PGND underneath the unit.

Figure 18 gives a good example of the recommended layout.

### LTM4602 Frequency Adjustment

The LTM4602 is designed to typically operate at 850kHz across most input and output conditions. The control architecture is constant on time valley mode current control. The  $f_{ADJ}$  pin is typically left open or decoupled with an optional 1000pF capacitor. The switching frequency has been optimized to maintain constant output ripple over the operating conditions. The equations for setting the operating frequency are set around a programmable constant on time. This on time is developed by a programmable current into an on board 10pF capacitor that establishes a ramp that is compared to a voltage threshold equal to the output voltage up to a 2.4V clamp. This  $I_{ON}$  current is equal to:  $I_{ON} = (V_{IN} - 0.7V)/110k$ , with the 110k onboard resistor



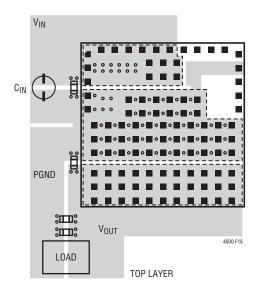


Figure 18. Recommended PCB Layout

from  $V_{IN}$  to  $f_{ADJ}$ . The on time is equal to  $t_{ON} = (V_{OUT}/I_{ON})$  • 10pF and  $t_{OFF} = t_s - t_{ON}$ . The frequency is equal to: Freq. = DC/ $t_{ON}$ . The  $I_{ON}$  current is proportional to  $V_{IN}$ , and the regulator duty cycle is inversely proportional to  $V_{IN}$ , therefore the step-down regulator will remain relatively constant frequency as the duty cycle adjustment takes place with lowering  $V_{IN}$ . The on time is proportional to  $V_{OUT}$  up to a 2.4V clamp. This will hold frequency relatively constant with different output voltages up to 2.4V. The regulator switching period is comprised of the on time and off time as depicted in Figure 19.

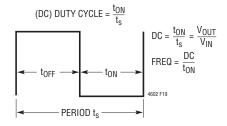


Figure 19. LTM4602 Switching Period

The LTM4602 has a minimum ( $t_{ON}$ ) on time of 100 nanoseconds and a minimum ( $t_{OFF}$ ) off time of 400 nanoseconds. The 2.4V clamp on the ramp threshold as a function of  $V_{OUT}$  will cause the switching frequency to increase by the ratio of  $V_{OUT}/2.4V$  for 3.3V and 5V outputs. This is due to the fact the on time will not increase as  $V_{OUT}$  increases past 2.4V. Therefore, if the nominal switching frequency is 850kHz, then the switching frequency will increase

to ~1.2MHz for 3.3V, and ~1.7MHz for 5V outputs due to Frequency =  $(DC/t_{ON})$  When the switching frequency increases to 1.2MHz, then the time period  $t_S$  is reduced to ~833 nanoseconds and at 1.7MHz the switching period reduces to ~588 nanoseconds. When higher duty cycle conversions like 5V to 3.3V and 12V to 5V need to be accommodated, then the switching frequency can be lowered to alleviate the violation of the 400ns minimum off time. Since the total switching period is  $t_S = t_{ON} + t_{OFF}$  $t_{OFF}$  will be below the 400ns minimum off time. A resistor from the f<sub>AD.I</sub> pin to ground can shunt current away from the on time generator, thus allowing for a longer on time and a lower switching frequency, 12V to 5V and 5V to 3.3V derivations are explained in the data sheet to lower switching frequency and accommodate these step-down conversions.

Equations for setting frequency for 12V to 5V:

$$I_{ON} = (V_{IN} - 0.7V)/110k; I_{ON} = 103\mu A$$

frequency =  $(I_{ON}/[2.4V \cdot 10pF]) \cdot DC = 1.79MHz$ ; DC = duty cycle, duty cycle is  $(V_{OUT}/V_{IN})$ 

 $t_S = t_{ON} + t_{OFF} t_{ON} = \text{on-time}, t_{OFF} = \text{off-time of the}$ switching period;  $t_S = 1/\text{frequency}$ 

 $t_{OFF}$  must be greater than 400ns, or  $t_S-t_{ON}>400$ ns.

$$t_{ON} = DC \cdot t_S$$

1MHz frequency or 1µs period is chosen for 12V to 5V.

$$t_{ON} = 0.41 \cdot 1 \mu s \approx 410 ns$$

$$t_{OFF} = 1\mu s - 410 ns \approx 590 ns$$

 $t_{\text{ON}}$  and  $t_{\text{OFF}}$  are above the minimums with adequate guard band.

Using the frequency =  $(I_{ON}/[2.4V \cdot 10pF]) \cdot DC$ , solve for  $I_{ON} = (1MHz \cdot 2.4V \cdot 10pF) \cdot (1/0.41) \approx 58\mu A$ .  $I_{ON}$  current calculated from 12V input was  $103\mu A$ , so a resistor from  $f_{ADJ}$  to ground =  $(0.7V/15k) = 46\mu A$ .  $103\mu A - 46\mu A = 57\mu A$ , sets the adequate  $I_{ON}$  current for proper frequency range for the higher duty cycle conversion of 12V to 5V. Input voltage range is limited to 9V to 16V. Higher input voltages can be used without the 15k on  $f_{ADJ}$ . The inductor ripple current gets too high above 16V, and the 400ns minimum off-time is limited below 9V.



Equations for setting frequency for 5V to 3.3V:

$$I_{ON} = (V_{IN} - 0.7V)/110k; I_{ON} = 39\mu A$$

frequency =  $(I_{ON}/[2.4V \cdot 10pF]) \cdot DC = 1.07MHz$ ; DC = duty cycle, duty cycle is  $(V_{OUT}/V_{IN})$ 

 $t_S = t_{ON} + t_{OFF} t_{ON} = \text{on-time}, t_{OFF} = \text{off-time of the switching period}; t_S = 1/\text{frequency}$ 

 $t_{OFF}$  must be greater than 400ns, or  $t_S - t_{ON} > 400$ ns.

$$t_{ON} = DC \cdot t_S$$

~450kHz frequency or 2.22µs period is chosen for 5V to 3.3V. Frequency range is about 450kHz to 650kHz from 4.5V to 7V input.

$$t_{ON} = 0.66 \cdot 2.22 \mu s \approx 1.46 \mu s$$

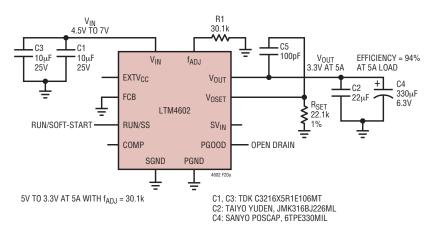
$$t_{OFF} = 2.22 \mu s - 1.46 \mu s \approx 760 ns$$

 $t_{\mbox{\scriptsize ON}}$  and  $t_{\mbox{\scriptsize OFF}}$  are above the minimums with adequate guard band.

Using the frequency =  $(I_{ON}/[2.4V \cdot 10pF]) \cdot DC$ , solve for  $I_{ON} = (450 \text{kHz} \cdot 2.4V \cdot 10pF) \cdot (1/0.66) \cong 16 \mu A$ .  $I_{ON}$  current calculated from 5V input was  $39 \mu A$ , so a resistor from  $f_{ADJ}$  to ground =  $(0.7V/30.1k) = 23 \mu A$ .  $39 \mu A - 23 \mu A = 16 \mu A$ , sets the adequate  $I_{ON}$  current for proper frequency range for the higher duty cycle conversion of 5V to 3.3V. Input voltage range is limited to 4.5V to 7V. Higher input voltages can be used without the 30.1k on  $f_{ADJ}$ . The inductor ripple current gets too high above 7V, and the 400ns minimum off-time is limited below 4.5V.

In 12V to 3.3V applications, if a 35k resistor is added from the  $f_{ADJ}$  pin to ground, then a 2% efficiency gain will be achieved as shown in the 12V efficiency graph in the Typical Performance Characteristics. This is due to the lower transition losses in the power MOSFETs after lowering the switching frequency down from 1.3MHz to 950kHz.

#### 5V to 3.3V at 5A



#### 12V to 5V at 5A

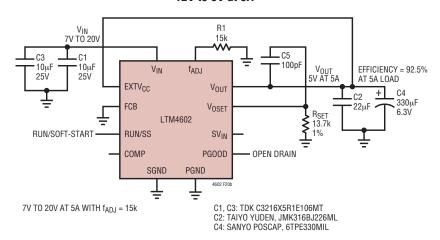


Figure 20.  $V_{IN}$  to  $V_{OUT}$  Step-Down Ratio for  $12V_{IN}$  to  $5V_{OUT}$  and  $5V_{IN}$  to  $3.3V_{OUT}$ 

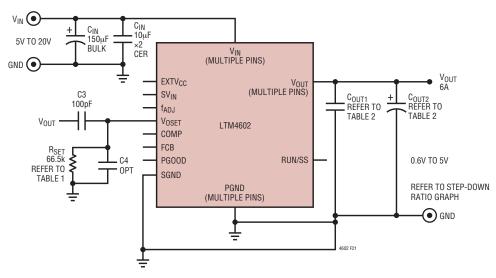
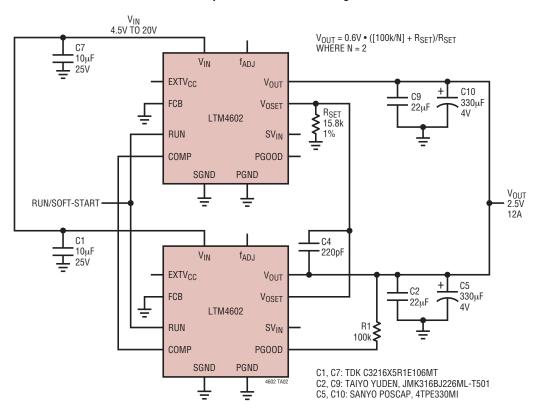


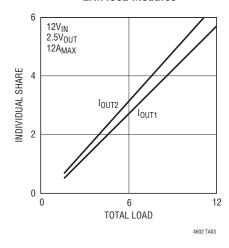
Figure 21. Typical Application, 5V to 20V Input, 0.6V to 5V Output, 6A Max

## TYPICAL APPLICATION

#### **Parallel Operation and Load Sharing**

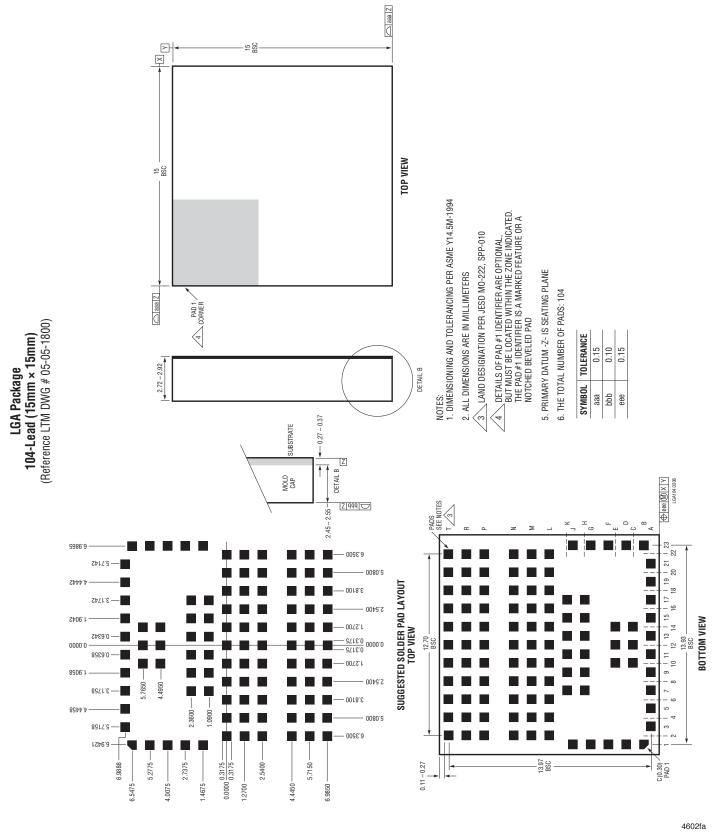


#### Current Sharing Between Two LTM4602 Modules



LINEAR

## PACKAGE DESCRIPTION



## PACKAGE DESCRIPTION

## Pin Assignment Tables (Arranged by Pin Number)

PIN NAME	PIN NAME	PIN NAME	PIN NAME	PIN NAME	PIN NAME	PIN NAME	PIN NAME
A1 -	B1 V <sub>IN</sub>	C1 -	D1 V <sub>IN</sub>	E1 -	F1 V <sub>IN</sub>	G1 PGND	H1 -
A2 -	B2 -	C2 -	D2 -	E2 -	F2 -	G2 -	H2 -
A3 V <sub>IN</sub>	B3 -	C3 -	D3 -	E3 -	F3 -	G3 -	Н3 -
A4 -	B4 -	C4 -	D4 -	E4 -	F4 -	G4 -	H4 -
A5 V <sub>IN</sub>	B5 -	C5 -	D5 -	E5 -	F5 -	G5 -	H5 -
A6 -	B6 -	C6 -	D6 -	E6 -	F6 -	G6 -	H6 -
A7 V <sub>IN</sub>	B7 -	C7 -	D7 -	E7 -	F7 -	G7 -	H7 PGND
A8 -	B8 -	C8 -	D8 -	E8 -	F8 -	G8 -	Н8 -
A9 V <sub>IN</sub>	В9 -	C9 -	D9 -	E9 -	F9 -	G9 -	H9 PGND
A10 -	B10 -	C10 V <sub>IN</sub>	D10 -	E10 V <sub>IN</sub>	F10 -	G10 -	H10 -
A11 V <sub>IN</sub>	B11 -	C11 -	D11 -	E11 -	F11 -	G11 -	H11 PGND
A12 -	B12 -	C12 V <sub>IN</sub>	D12 -	E12 V <sub>IN</sub>	F12 -	G12 -	H12 -
A13 V <sub>IN</sub>	B13 -	C13 -	D13 -	E13 -	F13 -	G13 -	H13 PGND
A14 -	B14 -	C14 V <sub>IN</sub>	D14 -	E14 V <sub>IN</sub>	F14 -	G14 -	H14 -
A15 f <sub>ADJ</sub>	B15 -	C15 -	D15 -	E15 -	F15 -	G15 -	H15 PGND
A16 -	B16 -	C16 -	D16 -	E16 -	F16 -	G16 -	H16 -
A17 SV <sub>IN</sub>	B17 -	C17 -	D17 -	E17 -	F17 -	G17 -	H17 PGND
A18 -	B18 -	C18 -	D18 -	E18 -	F18 -	G18 -	H18 -
A19 EXTV <sub>CC</sub>	B19 -	C19 -	D19 -	E19 -	F19 -	G19 -	H19 -
A20 -	B20 -	C20 -	D20 -	E20 -	F20 -	G20 -	H20 -
A21 V <sub>OSET</sub>	B21 -	C21 -	D21 -	E21 -	F21 -	G21 -	H21 -
A22 -	B22 -	C22 -	D22 -	E22 -	F22 -	G22 -	H22 -
A23 -	B23 COMP	C23 -	D23 SGND	E23 -	F23 RUN/SS	G23 FCB	H23 -

PI	N NAME	PIN NAME	PIN NAME	PIN NAME				
J1	PGND	K1 -	L1 -	M1 -	N1 -	P1 -	R1 -	T1 -
J2	-	K2 -	L2 PGND	M2 PGND	N2 PGND	P2 V <sub>OUT</sub>	R2 V <sub>OUT</sub>	T2 V <sub>OUT</sub>
J3	-	K3 -	L3 -	M3 -	N3 -	P3 -	R3 -	T3 -
J4	-	K4 -	L4 PGND	M4 PGND	N4 PGND	P4 V <sub>OUT</sub>	R4 V <sub>OUT</sub>	T4 V <sub>OUT</sub>
J5	-	K5 -	L5 -	M5 -	N5 -	P5 -	R5 -	T5 -
J6	-	K6 -	L6 PGND	M6 PGND	N6 PGND	P6 V <sub>OUT</sub>	R6 V <sub>OUT</sub>	T6 V <sub>OUT</sub>
J7	-	K7 PGND	L7 -	M7 -	N7 -	P7 -	R7 -	T7 -
J8	-	K8	L8 PGND	M8 PGND	N8 PGND	P8 V <sub>OUT</sub>	R8 V <sub>OUT</sub>	T8 V <sub>OUT</sub>
J9	-	K9 PGND	L9 -	M9 -	N9 -	P9 -	R9 -	Т9 -
J10	-	K10	L10 PGND	M10 PGND	N10 PGND	P10 V <sub>OUT</sub>	R10 V <sub>OUT</sub>	T10 V <sub>OUT</sub>
J11	-	K11 PGND	L11 -	M11 -	N11 -	P11 -	R11 -	T11 -
J12	-	K12 -	L12 PGND	M12 PGND	N12 PGND	P12 V <sub>OUT</sub>	R12 V <sub>OUT</sub>	T12 V <sub>OUT</sub>
J13	-	K13 PGND	L13 -	M13 -	N13 -	P13 -	R13 -	T13 -
J14	-	K14 -	L14 PGND	M14 PGND	N14 PGND	P14 V <sub>OUT</sub>	R14 V <sub>OUT</sub>	T14 V <sub>OUT</sub>
J15	-	K15 PGND	L15 -	M15 -	N15 -	P15 -	R15 -	T15 -
J16	-	K16 -	L16 PGND	M16 PGND	N16 PGND	P16 V <sub>OUT</sub>	R16 V <sub>OUT</sub>	T16 V <sub>OUT</sub>
J17	-	K17 PGND	L17 -	M17 -	N17 -	P17 -	R17 -	T17 -
J18	-	K18 -	L18 PGND	M18 PGND	N18 PGND	P18 V <sub>OUT</sub>	R18 V <sub>OUT</sub>	T18 V <sub>OUT</sub>
J19	-	K19 -	L19 -	M19 -	N19 -	P19 -	R19 -	T19 -
J20	-	K20 -	L20 PGND	M20 PGND	N20 PGND	P20 V <sub>OUT</sub>	R20 V <sub>OUT</sub>	T20 V <sub>OUT</sub>
J21	-	K21 -	L21 -	M21 -	N21 -	P21 -	R21 -	T21 -
J22	-	K22 -	L22 PGND	M22 PGND	N22 PGND	P22 V <sub>OUT</sub>	R22 V <sub>OUT</sub>	T22 V <sub>OUT</sub>
J23	PG00D	K23 -	L23 -	M23 -	N23 -	P23 -	R23 -	T23 -

LINEAR TECHNOLOGY

## PACKAGE DESCRIPTION

## Pin Assignment Tables (Arranged by Pin Number)

PIN NAME		
G1	PGND	
H7 H9 H11 H13 H15 H17	PGND PGND PGND PGND PGND PGND	
J1	PGND	
K7 K9 K11 K13 K15 K17	PGND PGND PGND PGND PGND PGND	
L2 L4 L6 L8 L10 L12 L14 L16 L18 L20 L22	PGND PGND PGND PGND PGND PGND PGND PGND	
M2 M4 M6 M8 M10 M12 M14 M16 M18 M20 M22	PGND PGND PGND PGND PGND PGND PGND PGND	
N2 N4 N6 N8 N10 N12 N14 N16 N18 N20 N22	PGND PGND PGND PGND PGND PGND PGND PGND	

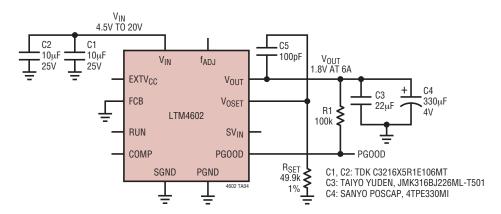
	`			
PIN NAME				
PIN N P2 P4 P6 P8 P10 P12 P14 P16 P18 P20 P22	VOUT VOUT VOUT VOUT VOUT VOUT VOUT VOUT			
R2 R4 R6 R8 R10 R12 R14 R16 R18 R20 R22	VOUT VOUT VOUT VOUT VOUT VOUT VOUT VOUT			
T2 T4 T6 T8 T10 T12 T14 T16 T18 T20 T22	VOUT VOUT VOUT VOUT VOUT VOUT VOUT VOUT			

PIN NAME		
A3 A5 A7 A9 A11 A13	VIN VIN VIN VIN VIN VIN	
B1	V <sub>IN</sub>	
C10 C12 C14	V <sub>IN</sub> V <sub>IN</sub> V <sub>IN</sub>	
D1	V <sub>IN</sub>	
E10 E12 E14	V <sub>IN</sub> V <sub>IN</sub> V <sub>IN</sub>	
F1	V <sub>IN</sub>	

PIN NAME		
A15	$f_{ADJ}$	
A17	$SV_{IN}$	
A19	$EXTV_CC$	
A21	V <sub>OSET</sub>	
B23	COMP	
D23	SGND	
F23	RUN/SS	
G23	FCB	
J23	PG00D	

## TYPICAL APPLICATION

#### 1.8V, 6A Regulator



## **RELATED PARTS**

PART NUMBER	DESCRIPTION	COMMENTS		
LTC2900 Quad Supply Monitor with Adjustable Reset Timer		Monitors Four Supplies; Adjustable Reset Timer		
LTC2923 Power Supply Tracking Controller		Tracks Both Up and Down; Power Supply Sequencing		
LT3825/LT3837	Synchronous Isolated Flyback Controllers	No Optocoupler Required; 3.3V, 12A Output; Simple Design		
LTM4600	10A DC/DC μModule	10A Basic DC/DC Module		
LTM4601	12A DC/DC µModule with PLL, Output Tracking/ Margining and Remote Sensing	Synchronizable, PolyPhase® Operation, LTM4601-1 Version has no Remote Sensing, Fast Transient Response		
LTM4603	6A DC/DC µModule with PLL and Output Tracking/ Margining and Remote Sensing	Synchronizable, PolyPhase Operation, LTM4603-1 Version has no Remote Sensing, Fast Transient Response		

 $\label{polyPhase} \mbox{PolyPhase is a registered trademark of Linear Technology Corporation}.$ 

